User manual of LTD-VL3000

LG Innotek

Product Name : Telematics Modem
Model Name : LTD-VL3000
FCC ID : YZP-VL3000

This LTD-VL3000 is a wireless module that is installed in a vehicle's telematics system and connects to CDMA (850/1900MHz) , LTE Band 2/4/5/13 wireless networks to have voice and data communication functions. It can be carried on land, rivers, and other similar areas and operated while stationary or moving. As a wireless facility device for personal portable communication, it is designed with ultra-small and up-to-date parts to realize small size and light weight.
Data communication is possible at uplink 1.8Mbps, downlink 3.1Mbps transmission speed when operating in CDMA(EVDO) mode, and uplink 50Mbps, downlink 150Mbps transmission speed when operating LTE Cat4 mode, so large amounts of data such as video or video calls can be received.
It communicates with the host system through the USB port, and receives control commands from the host system to enable data transmission and voice calls.

Pin map

LGA Pad Layout(Top veiw)

Total : 304 pins

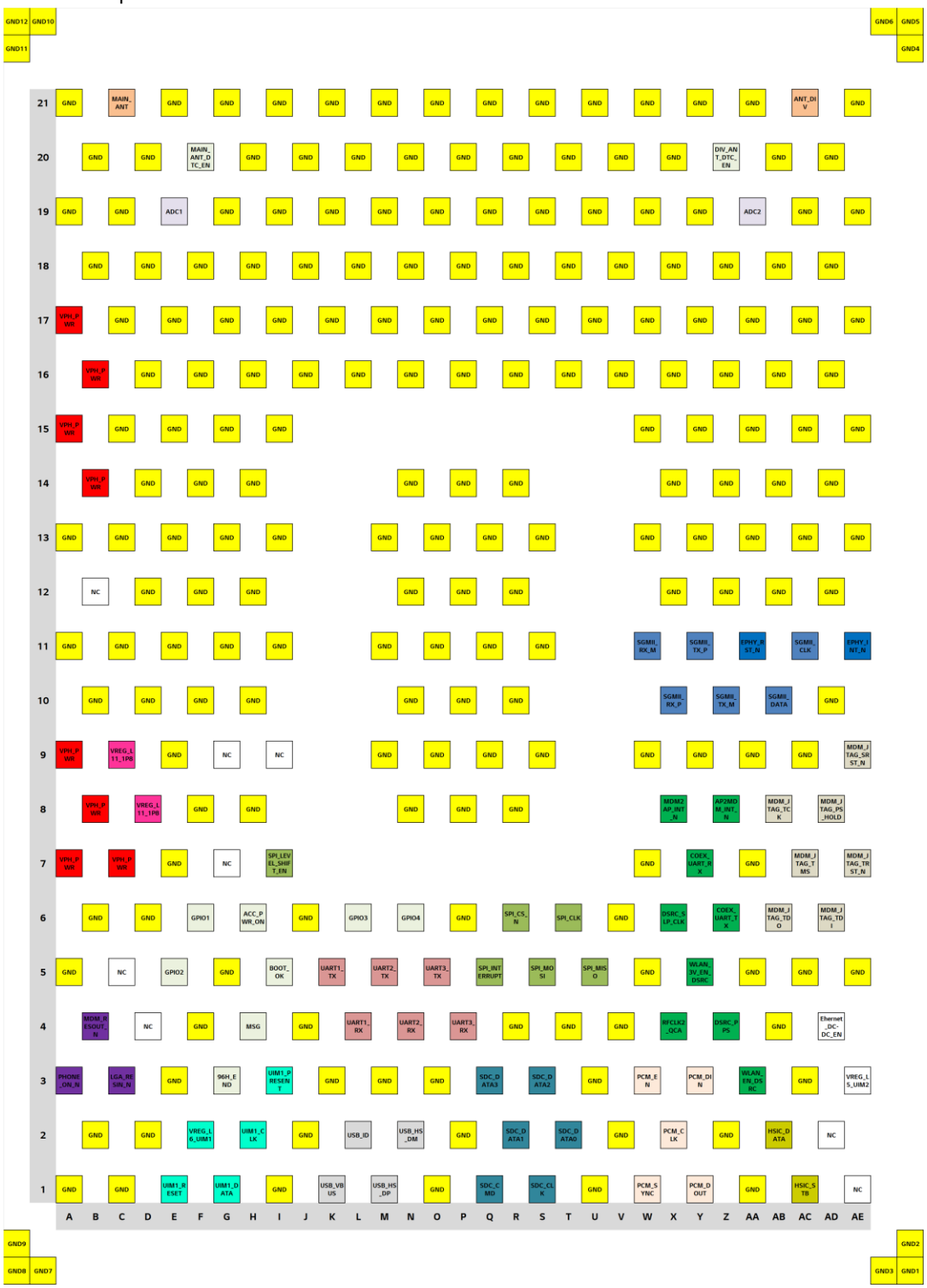

그림 1-1 LGA 인터페이스 핀 배열

Pin Descriptions

PAD.	NAME	DIRECTION	DESCRIPTION
Antenna Interface Pads			
C21	MAIN_ANT	Input/Output	RF Main Antenna
AC21	DIV_ANT	Input/Output	RF Diversity Antenna
User Interface Pads			
H6	ACC_PWR_ON	Input	ACC_PWR_ON
I5	BOOT_OK	Output	BOOT_OK
H4	MSG**	Output	MSG
G3	96H_END**	Output	
F20	MAIN_ANT_DTC_EN*,**	Output	Main ANT Detect Enable
Z20	DIV_ANT_DTC_EN**	Output	Diversity ANT Detect Enable
I7	SPI_LEVEL_SHIFT_EN*	Output	SPI LEVEL SHIFT Enable
AD4	ETHERNET_DCDC_ENABLE**	Output	Ethernet power enable
F6	GPIO1*	Output	General purpose I/O
E5	GPIO2*		General purpose I/O
L6	GPIO3**	Input/Output	General purpose I/O
N6	GPIO4**		General purpose I/O
ADC Interface Pads			
E19	ADC1	Input	ADC Convertor input for main antenna detect
AA19	ADC2	Input	ADC Convertor input for diversity antenna detect
PCM Interface Pads			
W3	PCM_EN**	Output	PCM 3.3 Level Shifter Enable
X2	PCM_CLK*,**	Input	PCM Clock
W1	PCM_SYNC	Input	PCM Frame Sync
Y3	PCM_DIN	Input	PCM Data In
Y1	PCM_DOUT**	Output	PCM Data Out
JTAG Pin Description			
AC7	MDM_JTAG_TMS	Input	JTAG mode select input
AD8	MDM_JTAG_PS_HOLD	input	JTAG PS HOLD detect
AD6	MDM_JTAG_TDI	Input	JTAG data input
AE7	MDM_JTAG_TRST_N	Input	JTAG reset for debug
AB6	MDM_JTAG_TDO	Output	JTAG debugging
AB8	MDM_JTAG_TCK	Input	JTAG clock input
AE9	MDM_JTAG_SRST_N	Input	JTAG reset
USB Interface Pads			

N2	USB_HS_DM	Input/Output	USB high speed data (minus)
M1	USB_HS_DP	Input/Output	USB high speed data (plus)
K1	USB_VBUS	Input	USB power
L2	USB_ID	Input	USB ID
SDIO Interface Pads			
S1	SDC_CLK	Output	Secure digital controller clock
Q1	SDC_CMD	Output	Secure digital controller command
T2	SDC_DATA0**	Input/Output	Secure digital controller data bit 0
R2	SDC_DATA1**	Input/Output	Secure digital controller data bit 1
S3	SDC_DATA2	Input/Output	Secure digital controller data bit 2
Q3	SDC_DATA3	Input/Output	Secure digital controller data bit 3
SGMMI Interface Pads			
AA11	EPHY_RST_N or UIM2_RESET	Output	Ethernet PHY reset or UIM2 reset
AE11	EPHY_INT_N or UIM2_DETECT	Input	Ethernet PHY interrupt or UIM2 DETECT
AB10	SGMII_DATA or UIM2_CLK	Input/Output	SGMII input Output data or UIM2_CLK
AD10	GND		Ground
X10	SGMII_RX_P	Input	SGMII receive - plus
W11	SGMII_RX_M	Input	SGMII receive -minus
Z10	SGMII_TX_M	Output	SGMII transmit - plus
Y11	SGMII_TX_P	Output	SGMII transmit -minus
AC11	SGMII_CLK or UIM2_DATA**	Input/Output	SGMII clock or UIM2_DATA
SPI Interface Pads			
S5	SPI_MOSI	Output	SPI Serial Output
T6	SPI_CLK**	Output	SPI Serial Clock
R6	SPI_CS_N	Output	SPI Chip Select
U5	SPI_MISO	Input	SPI Serial input
Q5	SPI_INTERRUPT	Input	MICOM → LGA SPI interrupt
UART Interface Pads			
M5	UART2_TX	Output	UART2 Transmit data
N4	UART2_RX	Input	UART2 Receive data
K5	UART1_TX**	Output	Debug UART5 Transmit Data
L4	UART1_RX	Input	Debug UART5 Receive Data
O5	UART3_TX**	Output	UART6 Transmit data
P4	UART3_RX	Input	UART6 Receive data
USIM Interface Pads			
I3	UIM1_PRESENT	Input	Detection of an external UIM card
H2	UIM1_CLK**	Output	Clock Output to an external UIM card
E1	UIM1_RESET**	Output	Reset Output to an external UIM card

G1	UIM1_DATA**	Input/Output	Data connection with an external UIM card
F2	VREG_L6_UIM1	Output	Supply Output for an external UIM card
E3	GND		Ground
D2	GND		Ground
A1	GND		Ground
C1	GND		Ground
B2	GND		Ground
HSIC Pin Description			
AB2	HSIC_DATA	Input/Output	HSIC data
AC1	HSIC_STB	Input/Output	HSIC Strobe signal
AD2	NC		No Connect
AE1	NC		No Connect
DSRC Pin Description			
Y7	COEX_UART_RX*	Input	LTE receiver sync for coexistence with UART
Z6	COEX_UART_TX**	Output	LTE transmitter sync for coexistence with UART
X4	RFCLK2_QCA	Output	Low noise RF clock Output
AA3	WLAN_EN_DSRC	Output	WLAN DSRC Enable
X6	DSRC_SLP_CLK	Output	DSRC sleep clock
Y5	WLAN_3V_EN_DSRC	Output	Used for WLAN enable
Z4	DSRC_PPS**	Input/Output	Pulse Per Second
X8	MDM2AP_INT_N**	Output	MDM to AP interrupt
Z8	AP2MDM_INT_N	Input	AP to MDM interrupt
Control Pin Description			
A3	LGA_PHONE_ON_N	Input	ON/OFF Control
B4	MDM_RESOUT_N	Output	Reset Output
C3	LGA_RESIN_N	Input	External Reset Input
Power Supply Pin Description			
A17	VPH_PWR for PAM	Input	power supply (4.0V)
B16	VPH_PWR for PAM	Input	power supply (4.0V)
A15	VPH_PWR for PAM	Input	power supply (4.0V)
B14	VPH_PWR for PAM	Input	power supply (4.0V)
A9	VPH_PWR for PMIC	Input	power supply (4.0V)
B8	VPH_PWR for PMIC	Input	power supply (4.0V)
A7	VPH_PWR for PMIC	Input	power supply (4.0V)
C7	VPH_PWR for PMIC	Input	power supply (4.0V)
Voltage Reference Pin Description			
C9	VREG_L11_1P8	Output	LDO out for 1.8V pull up
D8	VREG_L11_1P8	Output	LDO out for 1.8V pull up

AE3	Voltage Reference for SGMII (VREG_L5_UIM2) – Ethernet IO level	Output	Ethernet I/O voltage
NC Pads			
G9	NC		No Connect
B12	NC		No Connect
I9	NC		No Connect
G7	NC		No Connect
C5	NC		No Connect
D4	NC		No Connect
GND Pads			
A21	GND		Ground
E21	GND		Ground
G21	GND		Ground
I21	GND		Ground
K21	GND		Ground
M21	GND		Ground
O21	GND		Ground
Q21	GND		Ground
S21	GND		Ground
U21	GND		Ground
W21	GND		Ground
Y21	GND		Ground
AA21	GND		Ground
AE21	GND		Ground
B20	GND		Ground
D20	GND		Ground
H20	GND		Ground
J20	GND		Ground
L20	GND		Ground
N20	GND		Ground
P20	GND		Ground
R20	GND		Ground
T20	GND		Ground
V20	GND		Ground
X20	GND		Ground
AB20	GND		Ground
AD20	GND		Ground
A19	GND		Ground

C19	GND		Ground
G19	GND		Ground
I19	GND		Ground
K19	GND		Ground
M19	GND		Ground
O19	GND		Ground
Q19	GND		Ground
S19	GND		Ground
U19	GND		Ground
W19	GND		Ground
Y19	GND		Ground
AC19	GND		Ground
AE19	GND		Ground
B18	GND		Ground
D18	GND		Ground
F18	GND		Ground
H18	GND		Ground
J18	GND		Ground
L18	GND		Ground
N18	GND		Ground
P18	GND		Ground
R18	GND		Ground
T18	GND		Ground
V18	GND		Ground
X18	GND		Ground
Z18	GND		Ground
AB18	GND		Ground
AD18	GND		Ground
C17	GND		Ground
E17	GND		Ground
G17	GND		Ground
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K17	GND		Ground
M17	GND		Ground
O17	GND		Ground
Q17	GND		Ground
S17	GND		Ground
U17	GND		Ground

W17	GND		Ground
Y17	GND		Ground
AA17	GND		Ground
AC17	GND		Ground
AE17	GND		Ground
D16	GND		Ground
F16	GND		Ground
H16	GND		Ground
J16	GND		Ground
L16	GND		Ground
N16	GND		Ground
P16	GND		Ground
R16	GND		Ground
T16	GND		Ground
V16	GND		Ground
X16	GND		Ground
Z16	GND		Ground
AB16	GND		Ground
AD16	GND		Ground
C15	GND		Ground
E15	GND		Ground
G15	GND		Ground
I15	GND		Ground
W15	GND		Ground
Y15	GND		Ground
AA15	GND		Ground
AC15	GND		Ground
AE15	GND		Ground
D14	GND		Ground
F14	GND		Ground
H14	GND		Ground
X14	GND		Ground
Z14	GND		Ground
AB14	GND		Ground
AD14	GND		Ground
A13	GND		Ground
C13	GND		Ground
E13	GND		Ground

G13	GND		Ground
I13	GND		Ground
W13	GND		Ground
Y13	GND		Ground
AA13	GND		Ground
AC13	GND		Ground
AE13	GND		Ground
D12	GND		Ground
F12	GND		Ground
H12	GND		Ground
X12	GND		Ground
Z12	GND		Ground
AB12	GND		Ground
AD12	GND		Ground
A11	GND		Ground
C11	GND		Ground
E11	GND		Ground
G11	GND		Ground
I11	GND		Ground
B10	GND		Ground
D10	GND		Ground
F10	GND		Ground
H10	GND		Ground
E9	GND		Ground
W9	GND		Ground
Y9	GND		Ground
AA9	GND		Ground
AC9	GND		Ground
F8	GND		Ground
H8	GND		Ground
E7	GND		Ground
W7	GND		Ground
AA7	GND		Ground
B6	GND		Ground
D6	GND		Ground
J6	GND		Ground
P6	GND		Ground
V6	GND		Ground

A5	GND		Ground
W5	GND		Ground
AA5	GND		Ground
AC5	GND		Ground
AE5	GND		Ground
F4	GND		Ground
J4	GND		Ground
R4	GND		Ground
T4	GND		Ground
V4	GND		Ground
AB4	GND		Ground
K3	GND		Ground
M3	GND		Ground
O3	GND		Ground
U3	GND		Ground
AC3	GND		Ground
J2	GND		Ground
P2	GND		Ground
V2	GND		Ground
Z2	GND		Ground
I1	GND		Ground
O1	GND		Ground
U1	GND		Ground
AA1	GND		Ground
GND1	GND		Ground
GND2	GND		Ground
GND3	GND		Ground
GND4	GND		Ground
GND5	GND		Ground
GND6	GND		Ground
GND7	GND		Ground
GND8	GND		Ground
GND9	GND		Ground
GND10	GND		Ground
GND11	GND		Ground
GND12	GND		Ground
N14	GND		Ground
P14	GND		Ground

R14	GND		Ground
M13	GND		Ground
O13	GND		Ground
Q13	GND		Ground
S13	GND		Ground
N12	GND		Ground
P12	GND		Ground
R12	GND		Ground
M11	GND		Ground
O11	GND		Ground
Q11	GND		Ground
S11	GND		Ground
N10	GND		Ground
P10	GND		Ground
R10	GND		Ground
M9	GND		Ground
O9	GND		Ground
Q9	GND		Ground
S9	GND		Ground
N8	GND		Ground
P8	GND		Ground
R8	GND		Ground
G5	GND		Ground

Table - Pin Descriptions

Communication Specification

CDMA

Receiver

- Bandwidth: 1.25MHz
- Frequency: BC0(869 MHz – 894 MHz), BC1(1930 MHz – 1990 MHz)
- RF to Baseband Direct conversion (Zero IF)
- Modulation method: QPSK, 8PSK and 16QAM

Transceiver

- Frequency: BC0(824 MHz – 849 MHz), BC1(1850 MHz – 1910 MHz)
- Maximum RF Output: 23.01dBm ~ 30.0dBm max.(BC0-Power class3, BC1-Power class2)
- Modulation method: BPSK, QPSK and 8PSK
- Baseband to RF Direct conversion (Zero IF)

LTE

Receiver

- Bandwidth: B2/B4 (5 MHz, 10 MHz, 15 MHz, 20 MHz), B5/B13 (5 MHz, 10 MHz)
- Frequency: B2 (1930 MHz – 1990 MHz), B4 (2110 MHz – 2155 MHz),
  B5 (869 MHz – 894 MHz), B13 (746 MHz – 756 MHz)
- RF to Baseband Direct conversion (Zero IF)
- Modulation method: QPSK, 16QAM and 64QAM

Transceiver

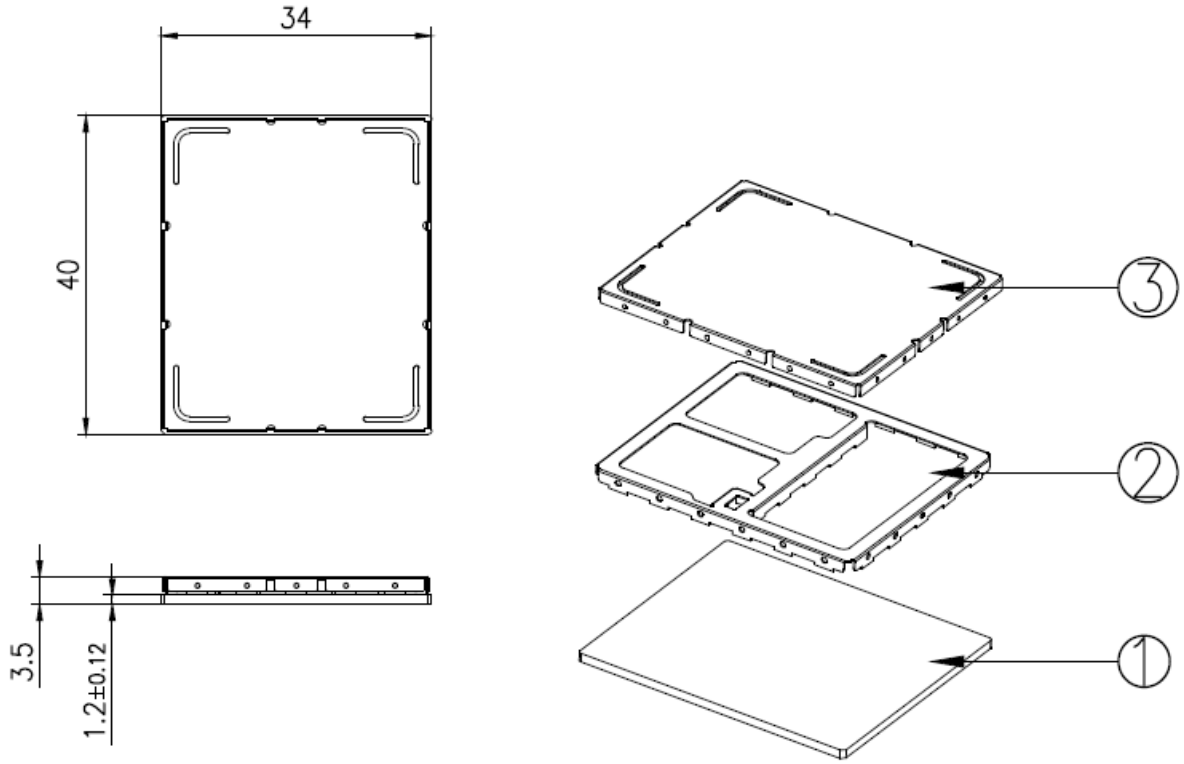
- Frequency: B2 (1850 MHz – 1910 MHz), B4 (1710 MHz – 1755 MHz),
  B5 (824 MHz – 849 MHz), B13 (777 MHz – 787 MHz),
- Maximum RF Output: Power class 3, 20.3dBm ~ 25.7dBm max.
- Modulation method: QPSK and 16QAM
- Baseband to RF Direct conversion (Zero IF)

Mechanical and Environmental Specification

Mechanical Dimensions

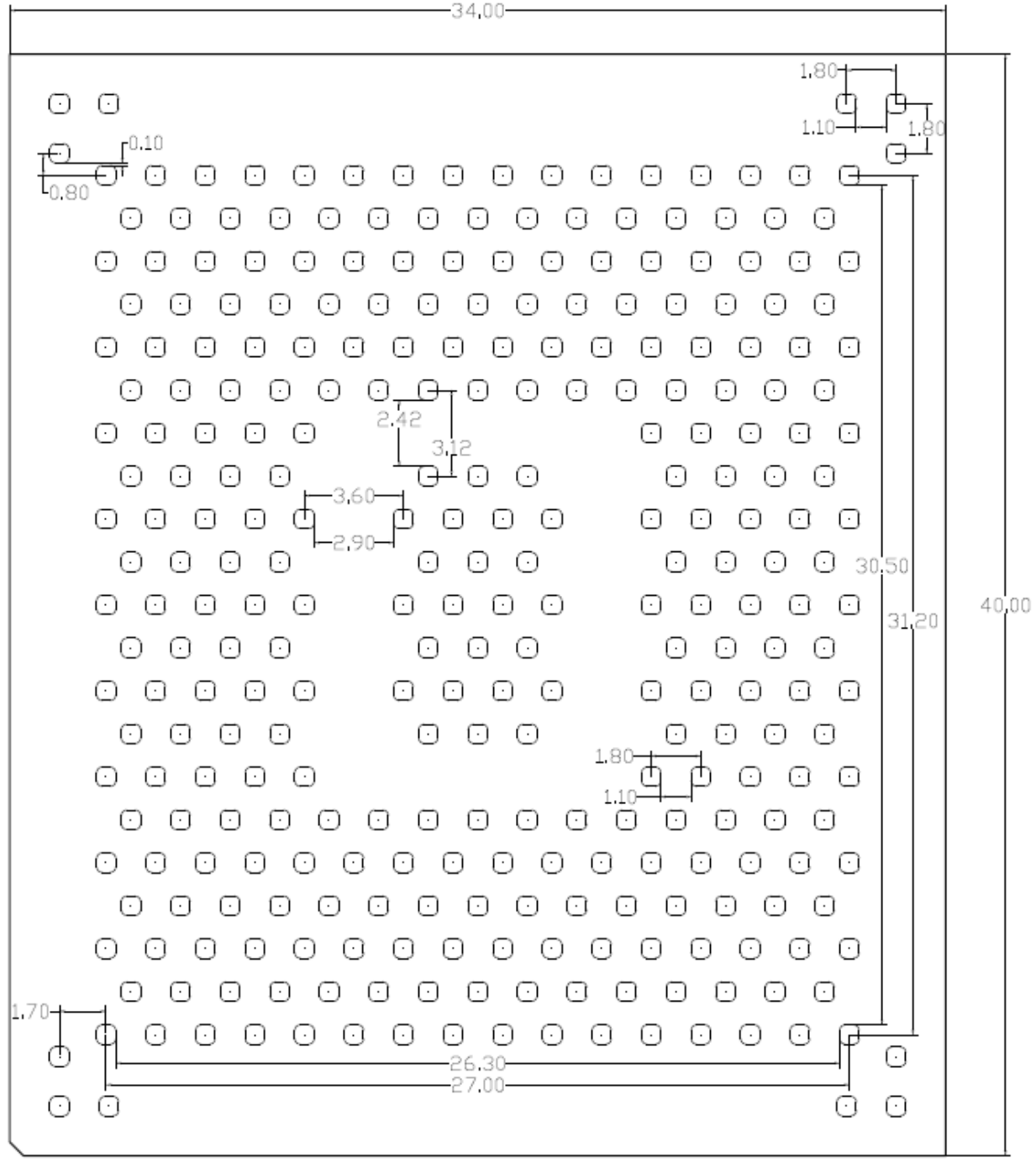
Dimensions	34.0 x 40.0 x 3.5 mm (L x W x T) (Tolerance – width, length: ±0.15 / height: ±0.2)
Weight	Max. 10.6 grams
Flatness	Max. 100 um

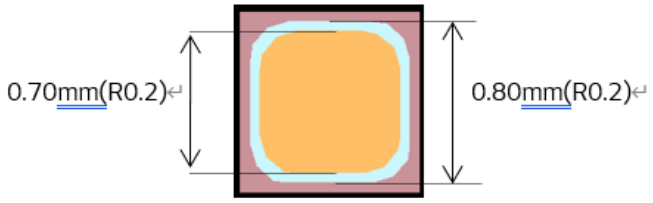
The Modem provides the RF shielding.



Mechanical Dimension

Footprint (Top View)





Modem PAD land size

Environmental Specification

1) Storage temperature : -40℃ ~ +85℃

2) Operation temperature :

Class A*	-20℃ ~ +70℃
Class B**	-30℃ ~ -20℃, +70℃ ~ +85℃

* Function(Voice call, data call, SMS) and 3GPP specification. (in normal operation.)

** Some performance of 3GPP specification may be degraded.

3) Operating humidity : 80% (60℃)

4) RoHS compliant

RFx Information

The strength of the RF field produced by the wireless module or modules embedded in the TCU is well within all international RF exposure limits known at this time.

Because the wireless modules embedded in the TCU emit less than the maximum amount of energy permitted in radio frequency safety standards and recommendations, the manufacturer believes these modules are safe for use.

Regardless of the power levels, care should be taken to minimize human contact during normal operation. This module should be remain more than 20 cm (8 inches) from the body when wireless devices are on and transmitting.

This transmitter must not be collocated or operated in conjunction with any other antenna or transmitter. Operation is subject to the following two conditions: (1) this module does not cause interference , (2) this module accepts any interference that may cause undesired operation.

Information for the integrator

The integrator must not provide information to the end user regarding how to install or remove this RF module in the user manual of the end product. The user manual that is provided by the integrator for end users must include the following information in a prominent location. To comply with FCC RF exposure requirements, the antenna used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be collocated or operated in conjunction with any other antenna or transmitter. The label for the end product must include **FCC ID: YZP-BK1100**.

Integration Guide

This module complies with FCC/IC rules.

FCC : Part 22, Part 24, Part 27

Furthermore, this device complies with FCCradiation exposure limits set forth for uncontrolled environments. This module must be installed and operated with minimum distance of 20 cm between the radiating element and the user. This module must not be co-located with any other transmitters or antennas.

To comply with FCC regulations limiting both the maximum RF output power and human exposure to RF radiation, the maximum antenna gain including cable loss in a mobile-only exposure condition must not exceed the values listed in the following table.

LTD-VL3000 Ant. Gain	Original Antenna 1	Additional Antenna 2	**Maximum**
CDMA BC0	4.5 dBi	2.18 dBi	**4.5 dBi**
CDMA BC1	2.0 dBi	5.97 dBi	**5.97 dBi**
LTE Band 2	2.0 dBi	5.97 dBi	**5.97 dBi**
LTE Band 4	2.0 dBi	4.13 dBi	**4.13 dBi**
LTE Band 5	4.5 dBi	2.18 dBi	**4.5 dBi**
LTE Band 13	4.5 dBi	-0.24 dBi	**4.5 dBi**

To satisfy the labeling requirements, the following text must appear on the exterior of the end product.

Contains transmitter module FCC ID: YZP-BK1100

Changes or modifications to this equipment may cause harmful interference unless
the modifications are expressly approved in the instruction manual. Users may lose the authority to operate this equipment if an unauthorized change or codification is made.

Note: If this module is intended for use in a portable device, additional testing will be required to satisfy the RF exposure and SAR requirements of FCC Part 2.1093.